

UNISONIC TECHNOLOGIES CO., LTD

UTT120P06

Preliminary

Power MOSFET

120A, 60V P-CHANNEL POWER MOSFET

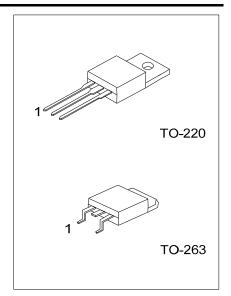
■ DESCRIPTION

The UTC **UTT120P06** is a P-channel power MOSFET using UTC's advanced technology to provide the customers with high switching speed and a minimum on-state resistance. It can also withstand high energy in the avalanche.

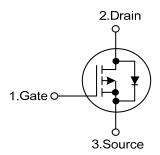
The UTC **UTT120P06** is suitable for low voltage and high speed switching applications



- * $R_{DS(ON)} \le 6.9 \text{m}\Omega$ @ $V_{GS} = -10V$
- * High Switching Speed



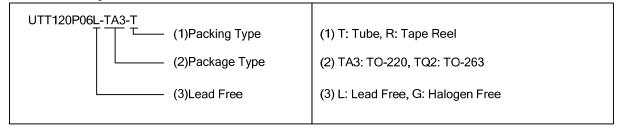
■ SYMBOL



ORDERING INFORMATION

| Ordering Number | | Dealtons | Pin Assignment | | | Doolsing | |
|------------------|------------------|-----------|----------------|---|---|-----------|--|
| Lead Free | Halogen Free | Package 1 | | 2 | 3 | Packing | |
| UTT120P06L-TA3-T | UTT120P06G-TA3-T | TO-220 | G | D | S | Tube | |
| UTT120P06L-TQ2-T | UTT120P06G-TQ2-T | TO-263 | G | D | S | Tube | |
| UTT120P06L-TQ2-R | UTT120P06G-TQ2-R | TO-263 | G | D | S | Tape Reel | |

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING INFORMATION

| PACKAGE | MARKING | | | |
|------------------|-----------------------------------------------------------|--|--|--|
| TO-220 TO-263 | UTC UTT120P06 ☐ L: Lead Free G: Halogen Free Lot Code 1 | | | |

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■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

| PARAMETER | | SYMBOL | RATINGS | UNIT | |
|--------------------------------------------------------|------------------|-----------------------|-------------------|--------------|----|
| Drain-Source V | oltage | | $V_{	extsf{DSS}}$ | -60 | V |
| Gate-Source Vo | oltage | | V_{GSS} | ±20 | V |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | -120 | Α | | | |
| | Continuous | T _C =125°C | ID | -95 | Α |
| | Pulsed | | I _{DM} | -480 | Α |
| Single Pulsed A | Avalanche Energy | L=-0.1mH | E _{AS} | 281 (Note 2) | mJ |
| Power Dissipation TO-220 TO-263 | | Ь | 192 | 14/ | |
| | | TO-263 | P_D | 178 | W |
| Junction Temperature | | T_J | +150 | °C | |
| Storage Temperature | | T _{STG} | -55~+150 | °C | |

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Duty cycle≦1%

■ THERMAL DATA

| PARAMETER | | SYMBOL | RATINGS | UNIT | |
|---------------------|--------|-----------------|---------|------|--|
| Junction to Ambient | | θ_{JA} | 62 | °C/W | |
| Junction to Case | TO-220 | 0 | 0.65 | °C/W | |
| | TO-263 | θ _{JC} | 0.70 | | |

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

| PARAMETER | | SYMBOL | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--------------------------------------------|-------------------|---------------------|----------------------------------------------------------------------|-----|-------|------|------|
| OFF CHARACTERISTICS | | | | | | | |
| Drain-Source Breakdown Voltage | | BV _{DSS} | I_D =-250 μ A, V_{GS} =0 V | -60 | | | V |
| Drain-Source Leakage Current | | , | V _{DS} =-60V, V _{GS} =0V | | | -1 | μΑ |
| | | I _{DSS} | V _{DS} =-60V,V _{GS} =0V,T _C =125°C | | | -50 | μΑ |
| Gate-Source Leakage Current | Forward | I _{GSS} | V _{GS} =+20V, V _{DS} =0V | | | +100 | nA |
| | Reverse | | V _{GS} =-20V, V _{DS} =0V | | | -100 | nA |
| ON CHARACTERISTICS | | | | | | | |
| Gate Threshold Voltage | | $V_{GS(TH)}$ | $V_{DS}=V_{GS}$, $I_{D}=-250\mu A$ | -1 | | -3 | V |
| | -: | | V _{GS} =-10V, I _D =-30A | | 5.5 | 6.9 | mΩ |
| Static Drain-Source On-State Re | sistance | $R_{DS(ON)}$ | V_{GS} =-4.5V, I_{D} =-30A | | 7.0 | 8.8 | mΩ |
| DYNAMIC PARAMETERS | | | | | | | |
| Input Capacitance | Input Capacitance | | | | 11400 | | pF |
| Output Capacitance | | Coss | V _{GS} =0V, V _{DS} =-25V, f=1.0MHz | | 1200 | | pF |
| Reverse Transfer Capacitance | | C _{RSS} | | | 900 | | pF |
| SWITCHING PARAMETERS | | | | | | | |
| Total Gate Charge | | Q_{G} | V _{DS} =-30V, V _{GS} =-10V, I _D =-110A | | 230 | 345 | nC |
| Gate to Source Charge Gate to Drain Charge | | Q_GS | | | 50 | | nC |
| | | Q_GD | | | 60 | | nC |
| Turn-ON Delay Time | | t _{D(ON)} | | | 20 | | ns |
| Rise Time | | t _R | V _{DD} =-30V, V _{GS} =-10V, I _D =-110A, | | 160 | 240 | ns |
| Turn-OFF Delay Time | | t _{D(OFF)} | $R_G=2.5\Omega$, $R_L=0.27\Omega$ | | 200 | | ns |
| Fall-Time | | t _F | | | 240 | 360 | ns |
| SOURCE- DRAIN DIODE RATIN | IGS AND | CHARACTE | RISTICS | | | | |
| Maximum Body-Diode Continuou | s Current | Is | | | | -120 | Α |
| Maximum Body-Diode Pulsed Current | | I _{SM} | | | | -480 | Α |
| Drain-Source Diode Forward Voltage | | V _{SD} | I _S =-120A, V _{GS} =0V | | -1.0 | -1.5 | V |
| Body Diode Reverse Recovery Time | | t _{rr} | 1 - 95A dl /dt-100A/ug | | 65 | 100 | ns |
| Body Diode Reverse Recovery Charge | | Q_{RR} | I _F =-85A, dI _F /dt=100A/μs | | 0.14 | 0.32 | nC |

Notes: 1. Pulse test, pulse width≤300µS, duty cycle≤2%



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